

# **OSD DISPLAYS**

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For Customer's Acceptance

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## Contents

• GENERAL INFORMATION	Page4
• ABSOLUTE MAXIMUM RATINGS	Page4
• ELECTRICAL CHARACTERISTICS	Page5
• BACKLIGHT SYSTEM CHARACTERISTICS	Page5
TIMING CHARACTERISTICS	Page6
• EXTERNAL DIMENSIONS	Page8
• ELECTRO-OPTICAL CHARACTERISTICS	Page9
• INTERFACE PIN ASSIGNMENT	Page11
• REFERENCE APPLICATION CIRCUIT	Page12
• REFERENCE INITIAL CODE	Page12
LCM PRODUCT INSPECTION CRITERIA	Page13
• PRECAUTIONS FOR USING LCD MODULES	Page20

## **◆GENERAL INFORMATION**

### 1.LCM Parameter

Item	Contents	Unit
LCD Type	TFT Transmissive Normal Black	/
Viewing Direction	Free	O' Clock
LCM Outline Dimension	229.45 (H) ×149.2 (V) ×2.4 (T)	mm
Active Area(W*H)	216.96 (H) ×135.6 (V)	mm
Number of Dots	1280*RGB×800	mm
Pixel Pitch (mm)	0.15(H) ×0.15 (V)	mm
Driver IC	TBD	/
Backlight Type	LED	/
Interface Type	LVDS	/
Weight	TBD	g

### 2.CTP Parameter

Item	Contents	Unit
Outline Size	239.6 (H) ×164.6 (V) ×1.8 (T)	mm
View Area	217.96 (H) ×136.6(V)	mm
Sensor Area	229.45 (H) ×149.2 (V)	mm
Sensor Channels	41×26	/
Interface Mode	IIC	/
Controller	MXT1066T2	/
I2C Address	0X4A	/
Touch Type	Multi Touch	/

### **♦**ABSOLUTE MAXIMUM RATINGS

#### 1.LCD Driver IC Parameter

Parameter	Symbol	Min.	Max.	Unit
Power Supply	VDD	-0.3	4.0	V
Operating temperature	Тор	-20	60	°C
Storage temperature	Tst	-30	70	°C
Humidity	RH	-	90%(Max60)	RH

## 2. CTP Controller IC Parameter

Parameter	Symbol	Min.	Max.	unit
Power Supply Voltage	VDD	-0.3	4.0	V

## *<del>+</del>ELECTRICAL CHARACTERISTICS*

#### 1. LCD Characteristics

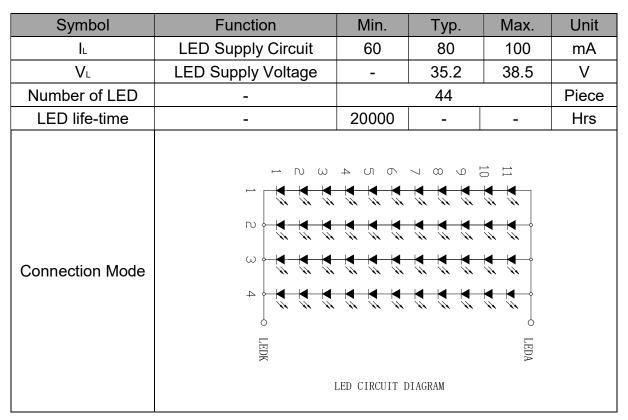
Parameter	Symbol	Min.	Тур.	Max.	Unit
Power Supply	VDD	3.0	3.3	3.6	V
Power Supply	IOVDD	XX	XX	XX	V

Input voltage ' H ' level	ViH	0.7VDD	-	VDD	V
Input voltage ' L ' level	VIL	GND	-	0.3VDD	V
Output voltage ' H ' level	Voh	0.8VDD	-	VDD	V
Output voltage ' L ' level	Vol	GND	-	0.2VDD	V

### 2.CTP Controller IC Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit
Interface Singal Voltage	IOVDD	XX	XX	XX	V
Power Voltage	VDD	3.0	3.3	3.6	V
Low Input Logic Level	Vil	-0.3	-	0.3VDD	V
High Input Logic Level	Vih	0.7VDD	-	VDD+0.5	V
Low Output Voltage	Vol	0	-	0.2VDD	V
High Output Voltage	Voh	0.8VDD	-	VDD	V

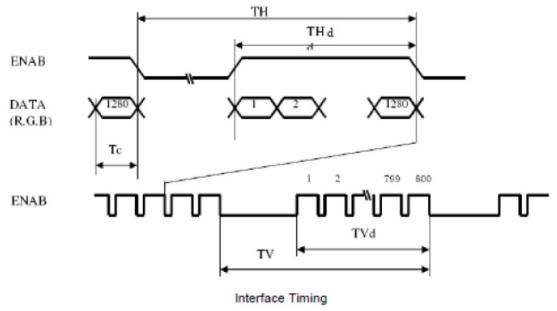
## **◆BACKLIGHT SYSTEM CHARACTERISTICS**



## **TIMING CHARACTERISTICS**

### 1.Timing Specification

Signal	Item	Symbol	Min	Туре	Max	Unit
DCLK	Frequency	1/TC	60	65	70	MHz
DCLK	Cycle	Tc	16.66	15.38	14.3	ns
	Horizontal Period	THd	1280	1280	1280	Tc
	Harimantal Ovala	TH	1310	1330	1560	Тс
DE	Horizontal Cycle	TH_time	19.5	20.46	21.83	ns
	Vertical Period	TVd	800	800	800	Tc
	Vertical Cycle	TV	-	812	-0	Tc



LVDS Rx Interface Timing Parameter

The specification of the LVDS Rx interface timing parameter is shown in Table 6.

Single-end Signals

NINDX

PINDX-NINDX=-|V\_{ID}|<br/>
R\_{IVCM}

PINDX-NINDX=|V\_{ID}|>R\_{IVT N}="HIGH" R\_{IVCM}

GND

Differential Signal

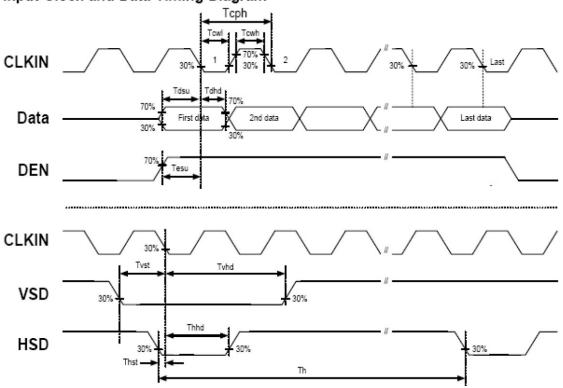
PINDX-NINDX

R\_{IVT N}

| |V\_{ID}| | |

<Table 6. LVDS Rx Interface Timing Specification>

## Input Clock and Data Timing Diagram



## 2. LVDS mode data input format

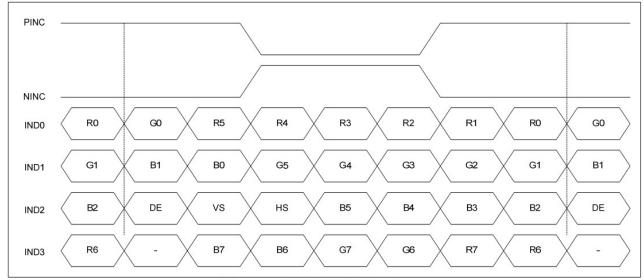


Figure: 8-bit LVDS Input

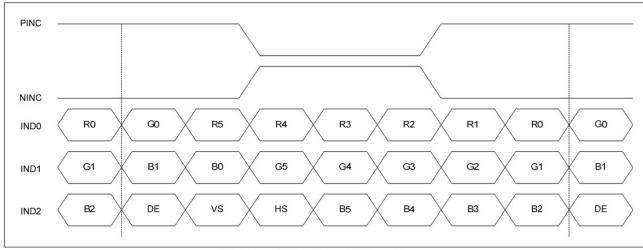
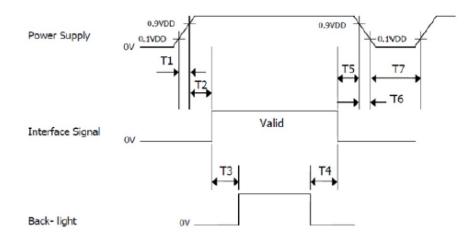


Figure: 6-bit LVDS input

### 3. Power Sequence

To prevent a latch-up or DC operation of the LCD module, the power on/off sequence shall be as shown in below

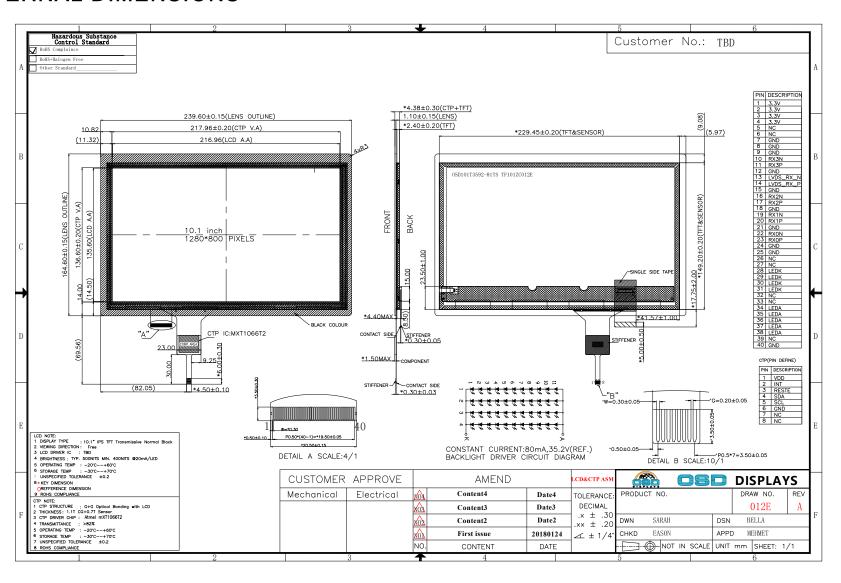
### Power-On/Off Timing Sequence:



D		TTOMO		
Parameter	Min	Тур	Max	Units
T1	0	-	10	ms
T2	0	-	50	ms
Т3	200	-	-	ms
T4	200	-	-	ms
T5	0.5	-	50	ms
Т6	0	-	10	ms
Т7	500	-	-	ms

9 / 21

### **◆ EXTERNAL DIMENSIONS**



10 / 21 10 / 21

## **♦ELECTRO-OPTICAL CHARACTERISTIC**

Item		Symbol	Condition	Min	Тур	Max	Unit	Note
Response	Response Time		Viewing	-	20	40	ms	4
Contrast	Ratio	Cr	Normal Angle	500	600	-	-	1
Luminance U	niformity	ΔL	_	75	80	-	%	3
Surface Lumi	nance	Lw	=0°	400	500	-	cd/m²	2
	Vertical	12o'clock		75	80	-	deg	
Viewing Angle	Vertical	6o'clock	CR≧10	75	80	-	deg	6
Range	Horizontal	3o'clock	011 10	75	80	-	deg	
		9o'clock		75	80	-	deg	
	RED	Х		0.5303	0.5703	0.6103	-	
CIE (x, y)		Y		0.2916	0.3316	0.3716		
Chromaticity	GREEN	Х		0.2903	0.3450	0.3850		
	OKEEN	Υ	_	0.6050	0.6478	0.6878		5
	BLUE	Х		0.1078	0.1455	0.1855		
	BLOL	Υ		0.0455	0.0856	0.1256		
	WHITE	Х		0.2756	0.3125	0.3525		
		Υ		0.3125	0.3531	0.3931		
NTSC R	atio	S	-	-	50%	-	-	7

Note1. Contrast Ratio (CR) is defined mathematically by the following formula. For more information see FIG 1.:

Contrast Ratio = Average Surface Luminance with all white pixels (P1, P2, P 3, P4, P5)

Average Surface Luminance with all black pixels (P1, P2, P 3, P4, P5)

Note2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 1.

Lv = Average Surface Luminance with all white pixels (P1, P2, P3,P4, P5)

Note3. The uniformity in surface luminance ( $\delta$  WHITE) is determined by measuring luminance at each test position 1 through 5, and then dividing the maximum luminance of 5 points luminance by minimum luminance of 5 points luminance. For more information see FIG 1.

δ WHITE = Minimum Surface Luminance with all white pixels (P1, P2, P3,P4,P5)

Maxi mum Surface Luminance with all white pixels (P1, P2, P3,P4,P5)

- Note4. Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 2...
- Note5. CIE (x, y) chromaticity ,The x,y value is determined by screen active area position 5. For more information see FIG 1.

Note6. Viewing angle is the angle at which the contrast ratio is greater than 2. For TFT module the contrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

Note7: NTSC ratio: For more information see FIG 4.

$$NTSC ratio = \frac{Area of RGB triangle}{Area of NTSC triangle}$$

Note8. For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface Luminance, Luminance uniformity and CIE, the testing data is base on BM-7 photo detector.

Note9. For TFT transmissive module, Gray scale reverse occurs in the direction of panel viewing angle

#### FIG.1. The definition of Response Time

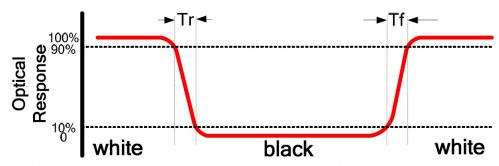


FIG.2. Measuring method for Contrast ratio, surface luminance, Luminance uniformity, CIE (x, y) chromaticity

A: 5 mm

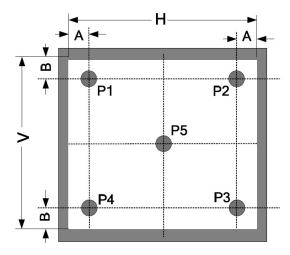
B: 5 mm

H,V: Active Area

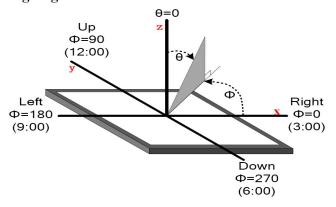
Light spot size ∅=5mm, 500mm distance from the LCD surface to detector lens

measurement instrument is TOPCON's luminance

meter BM-5



#### FIG.3. The definition of viewing angle



## **♦INTERFACE PIN ASSIGNMENT**

1. LCD Interface Pins Definition

PinNo.	Symbol	Description
1~4	3.3V	Logic power 3.3V
5~6	NC	No connect.
7~9	GND	Ground
10	RX3N	-LVDS differential data(R6,R7,G6,G7,B6,B7)
11	RX3P	+LVDS differential data(R6,R7,G6,G7,B6,B7)
12	GND	Ground
13	LVDS_RX_N	-LVDS differential clock input
14	LVDS_RX_P	+LVDS differential clock input
15	GND	Ground
16	RX2N	-LVDS differential data(B2~B5,HS,VS,DE)
17	RX2P	+LVDS differential data(B2~B5,HS,VS,DE)
18	GND	Ground
19	RX1N	-LVDS differential data(G1~G5,B0~B1)
20	RX1P	+LVDS differential data(G1~G5,B0~B1)
21	GND	Ground
22	RX0N	-LVDS differential data(R0~R5,G0)
23	RX0P	+LVDS differential data(R0~R5,G0)
24	GND	Ground
25	GND	Ground
26~27	NC	No connect.
28~31	LEDK	LED Power cathod
32~33	NC	No connect
34~38	LEDA	LED Power anode
39	NC	No connect.
40	GND	Ground

#### 2. TP Interface PINS Definition

PinNo. Symbol		Description
1	VDD (3.3V)	Power supply:3.3V.
2	INT	External interrupt to the host.
3	RESET	Reset pin,low is active.

4	SDA	I2C data input and output.
5	SCL	I2C clock input.
6	GND	Ground .
7	NC	No connect.
8	NC	No connect.

Note: IIC timing refer dirver chip datasheet.

## **\*REFERENCE APPLICATION CIRCUIT**

Please consult our technical department for detail information.

## **♦**REFERENCE INITIAL CODE

Please consult our technical department for detail information.

## **♦**LCM PRODUCT INSPECTION CRITERIA

#### 1 Description

This specification is made to be used as the standard acceptance/rejection criteria for TFT LCM Product.

#### 1.Sample plan

Sampling plan according to GB/T2828.1-2003/ISO 2859-1 : 1999 and ANSI/ASQC Z1.4-1993, normal level 2 and based on:

Major defect: AQL 0.65 Minor defect: AQL 1.5

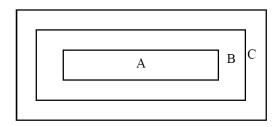
### 2. Inspection condition

•Viewing distance for cosmetic inspection is about  $30\pm5$ cm with bare eyes, and under an environment  $600\sim1000$ lux for visual inspection and  $0\sim200$ lux for function test., all directions for inspecting the sample should be within  $45^\circ$ against perpendicular line. (Normal temperature  $18\sim28^\circ$ C and normal humidity  $60\pm15\%$ RH).

#### Driving voltage

The Vop value from which the most optical contrast can be obtained near the specified Vop in the specification (Within  $\pm 0.5$ V of the typical value at 25°C.).

#### 3. Definition of inspection zone in LCD



Zone A: character/Digit area

Zone B: viewing area except Zone A (Zone A+Zone B=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig.1 Inspection zones in an LCD.

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.

#### 2 Inspection criterion

#### 2.1 Function defect

Items to be inspected	Inspection criterion	Classification of defects
	No display     Display abnormally	
All functional	3) Missing vertical, horizontal segment	
defects	<ul><li>4) Short circuit</li><li>5) Back-light no lighting, flickering and abnormal lighting.</li><li>6) obvious striation</li><li>7) Current beyond specification value</li></ul>	MA
Missing Component		
Outline dimension	Overall outline dimension exceed the drawing is not allowed.	

### 2.2 LCD pixel defect (bad dot)(defect type:MI)

Item		Inspection criterio	n
Size	S<5"	5"≤S<10"	10"≤S<15"
Color pixel dot defect(RGB dot)	1	2	2
2 connected bright dot	0	1	1
3 connected bright dot or more	0	0	1
Bright dot quantity	1	2	3
Random dark dot quantity	2	3	4
2 connected dark dot	1	1	2
3 connected dark dot or more	0	0	0
Dark dot quantity	3	4	5
Multi-bright dot		ND 3%hidden, OK	

Remark: 2 bright dots distance DS≥15mm 2 dark dots distance DS≥5mm

- 1) Bright dot: Power on TFT and RGB dot in black display
- 2) Dark dot: Power on TFT and gray or black dot in RGB display
- 3) Multi-bright dot: Power on TFT and fluorescent tiny dot in black display(only visible in black display)

### 2.3 dot and line defect(defect type:MI)

Checking	Judgment criterion					<b></b>
item	Diameter(mm	\LCD Size	S ≤5.0 Inch	5 < S≤7 Inch	7 < S≤12.3 Inch	Figure
	D≤0.15		allowed	allowed	allowed	
Dat data at	0.15 < D≤0.25		3	3	allowed	1 tb
Dot defect	D > 0.25		0	0	0	a
	the distance	between the tw	vo defect dot:	)S≥5mm		D=(a+b)/2
	Length(mm)	width(mm)		Judgment crite	erion	
	disregard	W≤0.05	allowed	allowed	allowed	<del>← L</del>
line defect	L≤2.5	0.05 < W≤0.1	3	3	7	, w
	L > 5	W > 0.1	0	0	0	
Concave	LCD Si	ze(mm)	Judgment criterion			
point and	D≤	≦0.2	allowed	allowed	allowed	
air bubble	0.2 <	D≤0.5	3	3	5	\$ь
for polarizer	D>	· 0.5	0	0	0	D=(a+b)/2
	Length ( mm)	width ( mm)		Judgment cri	terion	
	disregard	W≤0.05	allowed	allowed	allowed	
Fold mark	1 < L≤5	0.05 < W≤0.1	3	3	5	<b>←</b> L
linear scar	L > 5	W > 0.1	0	0	0	↓ w
	defect is judge	d with line judg	e; 2.If the fold	d mark and linea	e with operating on scar for polarized bove judgment sta	er is visible

### 2.4 Corner and others crack for LCD (defect type:MI)

Checking item	Judgment criterion	Figure
electric conduction crack	X≤3.0mm,Y≤1/4w,Z≤t,N≤2	J. J
corner crack	X≤3.0mm,Y≤3.0mm , Z≤t,N≤3 Corner crack extended to ITO PIN,none allowed	
surface crack	X≤1.5mm,Y≤1.0mm, Z≤t, N≤4	Z X Y X Y Y Y Y Y Y Y Y Y Y Y Y Y Y Y Y

2.5 Module Cosmetic Criteria(defect type:MI)

Item	Judgment Criterion
Difference in Spec.	None allowed
Pattern peeling	No substrate pattern peeling and floating
Soldering defects	No soldering missing No soldering bridge No cold soldering
	Notes:detail judgment referring to IPC-A-610 grade II
Resist flaw on Printed Circuit Boards	visible copper foil ( 0.5mm or more) on substrate pattern, none allowed
Accretion of metallic Foreign matter	No accretion of metallic foreign matters (Not exceed 0.2mm)
Stain	No stain to spoil cosmetic badly
Plate discoloring	No plate fading, rusting and discoloring
Newton ring	Referring to limited sample
Mura	Invisible with 5%ND,allowed
Light leaks	Referring to limited sample

3. Reliability test

No.	Test Item	Test Condition	Inspection after test
1	High Temperature Storage	70±2°C/96 hours	
2	Low Temperature Storage	-30±2°C/96 hours	
3	High Temperature Operation	60±2℃/96 hours	Inspection after 2~4 hours storage at
4	Low Temperature Operation	-20±2°C/96 hours	room temperature, the sample shall be
5	Temperature Cycle	-20±2℃(30min.) ~25(5min.)~70(30min.)±2℃ ~25(5min.) ×10cycles	free from defects:  1.Airbubblein the LCD;
6	Humidity Test	50℃±5℃×90%RH/96 hours	2.Sealleak;
7	Vibration Test	Frequency: 10Hz~55Hz~10Hz Amplitude: 1.5mm, X, Y, Z direction for total 0.5hours(Packing condition)	3.Non-display; 4.missing segments; 5.Glass crack; 6. Current ldd is twice higher than
8	Dropping test	Drop to the ground from 1.0m height, one time, every side of carton. (Packing condition)	initial value.
9	ESD test	Voltage:±8KV R: 330Ω C: 150pF Air discharge, 10time	

### Remark::

1. The test samples should be applied to only one test item.

- 2. Sample size for each test item is 5~10pcs.
- 3. For Damp Proof Test, Pure water(Resistance>10M $\Omega$ ) should be used.
- 4. In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.
- 5. EL evaluation should be excepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence EL has.
- 6. Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

#### 4. Symbol/Label . Package . Shipping and storage

- 4.1 Symbol/Label
- 4.1.1There should be manufacturing date and model no. information on the LCM.
- 4.2 Package
- 4.2.1 After inspection, put the LCMs into anti-static bags, and then packed into cartons. There should be clear, clean and tidy labels on the carton, indicating the below information:
- a) Name:
- b) Model No. & Qty;
- c) Customer;
- d) Manufacturing company or brand;
- e) There should be notification "Anti-humidity" on the obvious place of the carton. The notification should comply with GB/T 191-2008 standard.
- 4.3 Shipping
- 4.3.1 During the transportation, the package should be taken carefully to avoid collision and knocking. It is prohibited to put the package with causticity products, such as acid and alkali
- 4.3.2 There is no special requirement for the transportation tools, but it should ensure that during the transportation to avoid collision, rain and sown and erosion.
- 4.4 Storage
- 4.4.1 Put the LCMs into anti-static bags, store in normal temperature to avoid sunlight or Fluorescence light.
- 4.4.2 Avoid electrode erosion. Be cautious of water drop, humidity coagulation and high temperature that may accelerate electrode erosion.

### ◆PRECAUTIONS FOR USING LCD MODULES

**Handing Precautions** 

- (1) The display panel is made of glass and polarizer. As glass is fragile, it tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
- (2) If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- (3) Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).
- (4) The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.
- (5) If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents
  - Isopropyl alcohol
  - Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

- (6) Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
  - Water
  - Ketone
  - Aromatic solvents

Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contacting oil and fats.

- (7) Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- (8) Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- (9) Do not attempt to disassemble or process the LCD module.
- (10) NC terminal should be open. Do not connect anything.

- (11) If the logic circuit power is off, do not apply the input signals.
- (12) Electro-Static Discharge Control , Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
- Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.
- Tools required for assembling, such as soldering irons, must be properly grounded. Make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.
- To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential
- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.
- (13) Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.
  - Do not alter, modify or change the shape of the tab on the metal frame.
- Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
- Do not damage or modify the pattern writing on the printed circuit board.
- Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
- Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
  - Do not drop, bend or twist LCM.